

- () Preliminary Specifications (V) Final Specifications

Module	13.3"(13.25") HD 16:9 Color TFT-LCD with LED Backlight design
Model Name	B133XW03 V3 (H/W:0A)
Note	LED Backlight with driving circuit design ✓ Color Management (Virtual and Rich Color Solution) ✓ Dynamic Contrast Ratio (Power Saving Solution)

Customer	Date	Approved by Date	
		<u>Howard LEE</u> <u>04/14/20</u>	<u>110</u>
Checked & Approved by	Date	Prepared by	
		<u>YW LEE</u> <u>04/14/20</u>	<u>110</u>
Note: This Specification is s without notice.	ubject to change	NBBU Marketing Division AU Optronics corporation	



Contents

	. Handling Precautions	
2.	. General Description	
	2.1 General Specification	
_	2.2 Optical Characteristics	
	. Functional Block Diagram	
4.	. Absolute Maximum Ratings	12
	4.1 Absolute Ratings of TFT LCD Module	
	4.2 Absolute Ratings of Environment	
5.	. Electrical Characteristics	13
	5.1 TFT LCD Module	13
	5.2 Backlight Unit	16
6.	. Signal Interface Characteristic	17
	6.1 Pixel Format Image	17
	6.2 The Input Data Format	18
	6.3 Integration Interface Requirement	19
	6.4 Interface Timing	21
	6.5 Power ON/OFF Sequence	22
7.	. Panel Reliability Test	23
	7.1 Vibration Test	23
	7.2 Shock Test	23
	7.3 Reliability Test	23
8.	. Mechanical Characteristics	24
	8.1 LCM Outline Dimension	24
9.	. Shipping and Package	26
	9.1 Shipping Label Format	26
	9.2 Carton Package	27
	9.3 Shipping Package of Palletizing Sequence	
10	0. Appendix	
	10.1 EDID Description	
	10.2 Color Standardization Photographs	32



Record of Revision

Vei	rsion and Date	Page	Old description	New Description	Remark
0.1	2009/12/03	All	First Edition for Customer		
0.2	2010/02/10	6	TBD	Add RGB spec.	
0.1	2010/04/14	All	Final Edition for Customer		



AU OPTRONICS CORPORATION

1. Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open nor modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
- 11)After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
- 12) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
- 13) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electrostic breakdown.



2. General Description

B133XW03 V3 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the 16:9 HD, 1366(H) x768(V) screen and 262k colors (RGB 6-bits data driver) with LED backlight driving circuit. All input signals are LVDS interface compatible.

B133XW03 V3 is designed for a display unit of notebook style personal computer and industrial machine.

2.1 General Specification

The following items are characteristics summary on the table at 25 $^{\circ}\mathrm{C}$ condition:

Items	Unit	Specifications			
Screen Diagonal	[mm]	336.6 (13.2	25W")		
Active Area	[mm]	293.42 X 1	64.97		
Pixels H x V		1366x3(RGB) x 768			
Pixel Pitch	[mm]	0.2148X0.2	2148		
Pixel Format		R.G.B. Ver	tical Stripe		
Display Mode		Normally W	/hite		
White Luminance (ILED=20mA) (Note: ILED is LED current)	[cd/m ²]	200 typ. (5 points average) 170 min. (5 points average)			
Luminance Uniformity		1.25 max. (5 points)		
Contrast Ratio		400 typ, 30	0 min.		
Response Time	[ms]	8 typ / 16 N	1 ax		
Nominal Input Voltage VDD	[Volt]	+3.3 typ.			
Power Consumption	[Watt]	3.0 max. (li	nclude Logic	and Blu po	wer)
Weight	[Grams]	310 max.			
	[mm]		Min.	Тур.	Max.
Physical Size		Length	316.7	317.2	317.7
Include bracket		Width	188.2	188.7	189.2
		Thickness	-	-	3.6
Electrical Interface		1 channel l	_VDS		
Glass Thickness	[mm]	0.5			
Surface Treatment		AG, Hardness 3H			
Support Color		262K colors	s(RGB 6-bi	t)	



Temperature Range Operating Storage (Non-Operating)	[°C] [°C]	0 to +50 -20 to +60
RoHS Compliance		RoHS Compliance

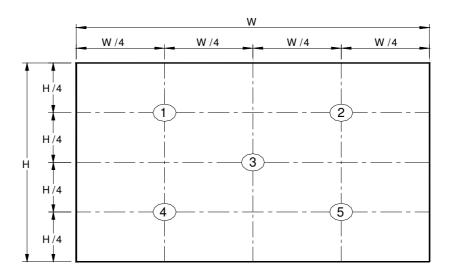
2.2 Optical Characteristics

The optical characteristics are measured under stable conditions at 25°C (Room Temperature):

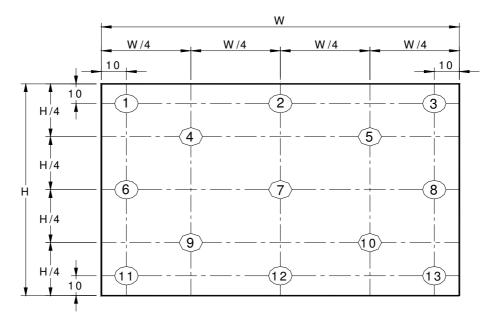
Item		Symbol	Conditions	Min.	Тур.	Max.	Unit	Note
White Luminance ILED=20mA			5 points average	170	200	-	cd/m ²	1, 4, 5.
		θ_{R}	Horizontal (Right)	40	45	-		
Viewing A	ngle	θ∟	CR = 10 (Left)	40	45	-	degree	4, 9
	J	ф н	Vertical (Upper)	10	15	-	degree	7, 0
		φ _L	CR = 10 (Lower)	30	35	-		
Luminan Uniformi		δ 5P	5 Points	-	-	1.25		1, 3, 4
Luminan Uniformi		δ _{13P}	13 Points	-	-	1.50		2, 3, 4
Contrast R	atio	CR		400	500	-		4, 6
Cross ta	lk	%				4		4, 7
Response ⁻	Time	T _{RT}	Rising + Falling	-	8	16	msec	4, 8
	Red	Rx		0.560	0.590	0.620		
	neu	Ry		0.315	0.345	0.375		
	Croon	Gx		0.295	0.325	0.355		
Color /	Green	Gy		0.510	0.540	0.570		
Coodinates	Chromaticity Coodinates		CIE 1931	0.120	0.150	0.180		4
	Blue	Ву		0.115	0.145	0.175		
	\\/\b:+-	Wx		0.283	0.313	0.343		
	White	Wy		0.299	0.329	0.359		
NTSC		%		-	45	-		



Note 1: 5 points position (Ref: Active area)



Note 2: 13 points position (Ref: Active area)



Note 3: The luminance uniformity of 5 or 13 points is defined by dividing the maximum luminance values by the minimum test point luminance

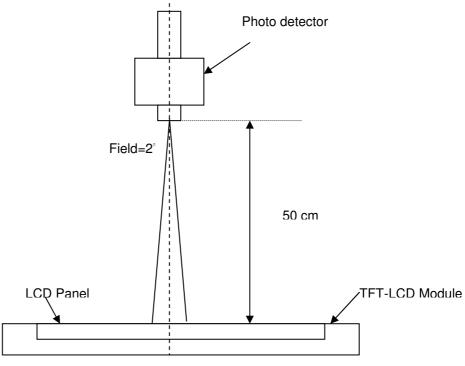
2		Maximum Brightness of five points
δ w5	=	Minimum Brightness of five points
2		Maximum Brightness of thirteen points
δ w13	= '	Minimum Brightness of thirteen points

Note 4: Measurement method

The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting



Backlight for 30 minutes in a stable, windless and dark room, and it should be measured in the center of screen.



Center of the screen

Note 5: Definition of Average Luminance of White (Y_L):

Measure the luminance of gray level 63 at 5 points \cdot $Y_L = [L(1) + L(2) + L(3) + L(4) + L(5)] / 5$ L (x) is corresponding to the luminance of the point X at Figure in Note (1).

Note 6: Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

Note 7: Definition of Cross Talk (CT)

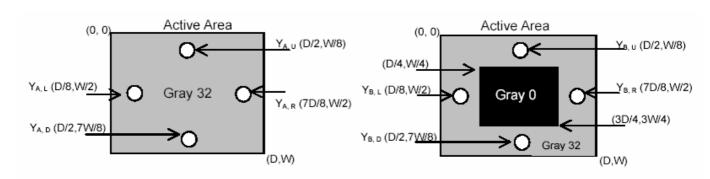
$$CT = |Y_B - Y_A| / Y_A \times 100 (\%)$$

Where

Y_A = Luminance of measured location without gray level 0 pattern (cd/m₂)

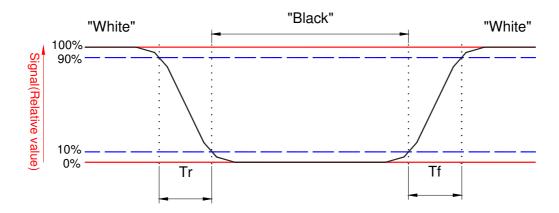
Y_B = Luminance of measured location with gray level 0 pattern (cd/m₂)





Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from "Black" to "White" (falling time) and from "White" to "Black" (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.

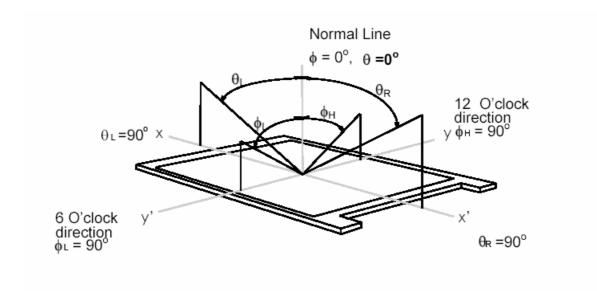




AU OPTRONICS CORPORATION

Note 9. Definition of viewing angle

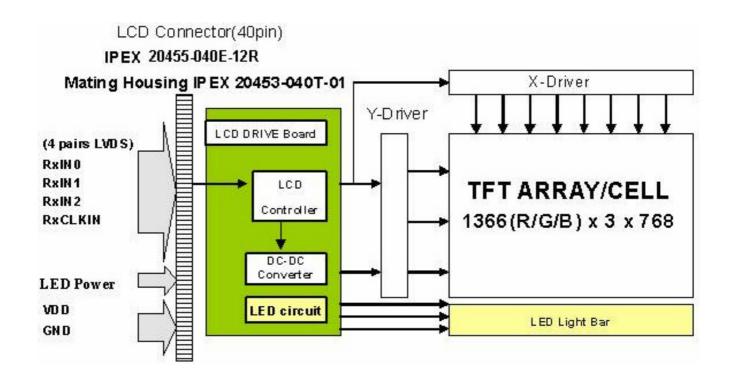
Viewing angle is the measurement of contrast ratio \geq 10, at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° (θ) horizontal left and right and 90° (Φ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.





3. Functional Block Diagram

The following diagram shows the functional block of the 13.3 inches wide Color TFT/LCD 40 Pin one channel Module





AU OPTRONICS CORPORATION

4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive Voltage	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.2 Absolute Ratings of Environment

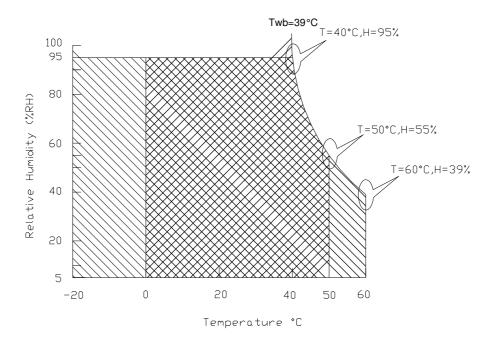
Item	Symbol	Min	Max	Unit	Conditions			
Operating Temperature	TOP	0	+50	[°C]	Note 4			
Operation Humidity	HOP	5	95	[%RH]	Note 4			
Storage Temperature	TST	-20	+60	[°C]	Note 4			
Storage Humidity	HST	5	95	[%RH]	Note 4			

Note 1: At Ta (25°C)

Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).



Operating Range

Storage Range

+

5. Electrical Characteristics

5.1 TFT LCD Module

5.1.1 Power Specification

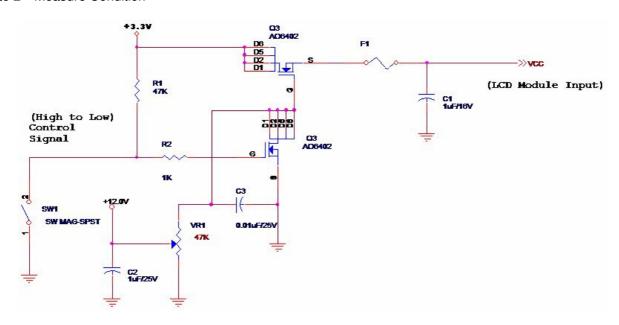
Input power specifications are as follows;

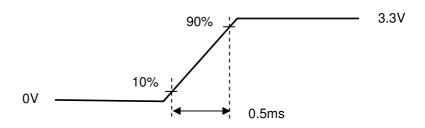
The power specification are measured under 25°C and frame frenquency under 60Hz

Symble	Parameter	Min	Тур	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	ı	-		[Watt]	Note 1
IDD	IDD Current	ı	-		[mA]	Note 1
IRush	Inrush Current	-	-		[mA]	Note 2
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-		[mV] p-p	

Note 1: Maximum Measurement Condition: Black Pattern at 3.3V driving voltage. (P_{max}=V_{3.3} x I_{black})

Note 2: Measure Condition





Vin rising time



5.1.2 Signal Electrical Characteristics

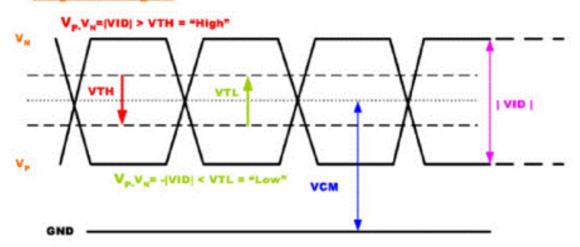
Input signals shall be low or High-impedance state when VDD is off.

Signal electrical characteristics are as follows;

Parameter	Condition	Min	Max	Unit
V _{TH}	Differential Input High Threshold (Vcm=+1.2V)		100	[mV]
V _{TL}	Differential Input Low Threshold (Vcm=+1.2V)	-100	-	[mV]
V _{ID}	Differential Input Voltage	100	600	[mV]
V _{CM}	Differential Input Common Mode Voltage	1.125	1.375	[V]

Note: LVDS Signal Waveform

Single-end Signal





5.1.3 Color Management Characteristics

Parameter	Symbol	Min	Тур	Max	Units	Remark
Color Management Input High Level	IMG EN	3.0	-	5.5	[Volt]	Define as Connector
Color Management Input Low Level	IIVIG_LIV	-	-	0.8	[Volt]	Interface (Ta=25°C)

5.1.4 Dynamic contrast ratio Characteristics

Parameter	Symbol	Min	Тур	Max	Units	Remark
Dynamic contrast ratio(DCR) Input High Level		3.0	-	5.5	[Volt]	Define as Connector
Dynamic contrast ratio(DCR) Input Low Level	DCR_EN	-	-	0.8	[Volt]	Interface (Ta=25°C)
DCR Mode Duty Index	Duty	55	-	85	%	Note 1
L0 Gray level	Power	0.45P	0.55P	0.65P	Watt	
L63 Gray level	Power	0.75P	0.85P	0.95P	Watt	Note 2

Note 1: The minimums dynamic contrast ratio is setting at darkness, and a maximum is setting at brightness.

Note 2: The power saving capability refer to original Backlight power consumption (P)



5.2.1 LED characteristics

Parameter	Symbol	Min	Тур	Max	Units	Condition
Backlight Power Consumption	PLED	-	-	2.2	[Watt]	(Ta=25°C), Note 1 Vin =12V
LED Life-Time	N/A	10,000	-	-	Hour	(Ta=25°C), Note 2 I _F =20 mA

Note 1: Calculator value for reference P_{LED} = VF (Normal Distribution) * IF (Normal Distribution) / Efficiency

Note 2: The LED life-time define as the estimated time to 50% degradation of initial luminous.

5.2.2 Backlight input signal characteristics

Parameter	Symbol	Min	Тур	Max	Units	Remark
LED Power Supply	VLED	6.0	12.0	21.0	[Volt]	
LED Enable Input High Level	VLED EN	2.5	-	5.5	[Volt]	
LED Enable Input Low Level	VLLD_LIN	-	-	0.8	[Volt]	Define as
PWM Logic Input High Level	\/D\\/\AE\	2.5	-	5.5	[Volt]	Connector
PWM Logic Input Low Level	VPWM_EN	-1	-	0.8	[Volt]	(Ta=25°C)
PWM Input Frequency	FPWM	100	-	20K	Hz	
PWM Duty Ratio	Duty	5		100	%	



6. Signal Interface Characteristic

6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.

	1					130	56
1st Line	R G B	R G B		R G	В	R (G B
	1	1	•	1			
		· ·	•				
		•	•				
							.
			•				
			•				
	,	•	•	•			
768th Line	R G B	R G B		R	В	R	В



6.2 The Input Data Format

RxCLKIN		
RxIN0	G0 R5 R4 R3 R2	R1 R0
RxIN1	B1 B0 G5 G4 G3	G2 G1 X
RxIN2	DE VS HS B5 B4	B3 B2

Cianal Nama	Description	
Signal Name	Description (MCD)	Dad shall Date
R5	Red Data 5 (MSB)	Red-pixel Data
R4	Red Data 4	Each red pixel's brightness data consists of
R3	Red Data 3	these 6 bits pixel data.
R2	Red Data 2	
R1	Red Data 1	
R0	Red Data 0 (LSB)	
	Red-pixel Data	
	·	
G5	Green Data 5 (MSB)	Green-pixel Data
G4	Green Data 4	Each green pixel's brightness data consists of
G3	Green Data 3	these 6 bits pixel data.
G2	Green Data 2	
G1	Green Data 1	
G0	Green Data 0 (LSB)	
D -	Green-pixel Data	5
B5	Blue Data 5 (MSB)	Blue-pixel Data
B4	Blue Data 4	Each blue pixel's brightness data consists of
B3	Blue Data 3	these 6 bits pixel data.
B2	Blue Data 2	
B1	Blue Data 1	
B0	Blue Data 0 (LSB)	
	Blue-pixel Data	
RxCLKIN	Data Clock	The signal is used to strobe the pixel data and
IIAOLININ	Data Ciuck	DE signals. All pixel data shall be valid at the
DE	Dioplay Timing	falling edge when the DE signal is high.
DE	Display Timing	This signal is strobed at the falling edge of
		RxCLKIN. When the signal is high, the pixel
VC	Vartical Cura	data shall be valid to be displayed.
VS	Vertical Sync	The signal is synchronized to RxCLKIN.
HS	Horizontal Sync	The signal is synchronized to RxCLKIN.

Note: Output signals from any system shall be low or High-impedance state when VDD is off.



6.3 Integration Interface Requirement

6.3.1 Connector Description

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

Connector Name / Designation	For Signal Connector
Manufacturer	IPEX or Compatible
Type / Part Number	IPEX 20455-040E-12R or Compatible
Mating Housing/Part Number	IPEX 20453-040T-11or Compatible

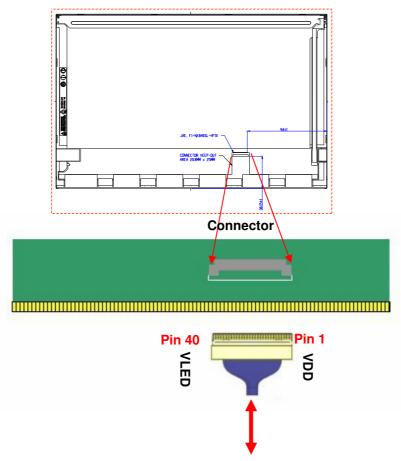
6.3.2 Pin Assignment

LVDS is a differential signal technology for LCD interface and high speed data transfer device.

PIN#	Signal Name	Description			
1	NC	No Connection (Reserve)			
2	VDD	Power Supply +3.3V			
3	VDD	Power Supply +3.3V			
4	VEDID	EDID +3.3V Power			
5	NC	No Connect (Reserve)			
6	CLK_EDID	EDID Clock Input			
7	DAT_EDID	EDID Data Input			
8	RxOIN0-	-LVDS Differential Data INPUT(Odd R0-R5,G0)			
9	RxOIN0+	+LVDS Differential Data INPUT(Odd R0-R5,G0)			
10	VSS	Ground			
11	RxOIN1-	-LVDS Differential Data INPUT(Odd G1-G5,B0-B1)			
12	RxOIN1+	+LVDS Differential Data INPUT(Odd G1-G5,B0-B1)			
13	VSS	Ground			
14	RxOIN2-	-LVDS Differential Data INPUT(Odd B2-B5,HS,VS,DE)			
15	RxOIN2+	+LVDS Differential Data INPUT(Odd B2-B5,HS,VS,DE)			
16	VSS	Ground			
17	RxOCKIN-	-LVDS Odd Differential Clock INPUT			
18	RxOCKIN+	-LVDS Odd Differential Clock INPUT			
19	IMG_EN	Color Management Input Level			
20	NC	No connection			
21	NC	No connection			
22	NC	No connection			



23	NC	No connection
24	NC	No connection
25	NC	No connection
26	NC	No connection
27	NC	No connection
28	NC	No connection
29	NC	No connection
30	NC	No connection
31	VLED_GND	LED Ground
32	VLED_GND	LED Ground
33	VLED_GND	LED Ground
34	NC	No Connection (Reserve)
35	VPWM_EN	PWM logic input level
36	VLED_EN	LED enable input level
37	DCR_EN	Dynamic Contrast Ratio Input Level
38	VLED	LED Power Supply 6V-21V
39	VLED	LED Power Supply 6V-21V
40	VLED	LED Power Supply 6V-21V



Note1: Input signals shall be low or High-impedance state when VDD is off.



AU OPTRONICS CORPORATION

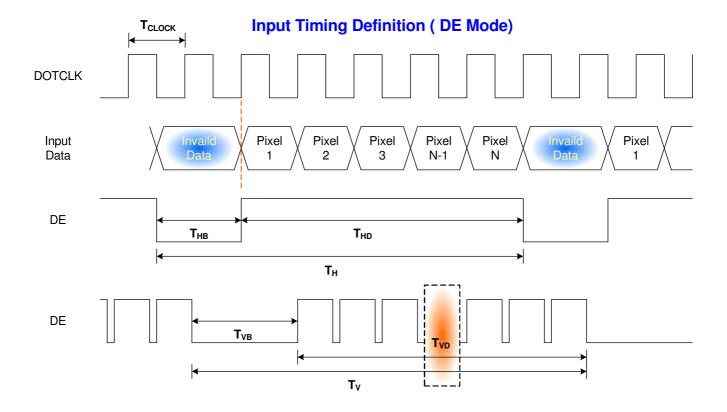
6.4.1 Timing Characteristics

Basically, interface timings should match the 1366x768 /60Hz manufacturing guide line timing.

Parameter		Symbol	Min.	Тур.	Max.	Unit
Frame	e Rate	-	50 60 -		Hz	
Clock fr	equency	1/ T _{Clock}	50	69.5	80	MHz
	Period	T _V	776	790	1000	
Vertical	Active	T _{VD}	768			T_{Line}
Section	Blanking	T _{VB}	8	22	232	
	Period	T _H	1426	1466	2000	
Horizontal	Active	T _{HD}		1366		T _{Clock}
Section	Blanking	T _{HB}	60	100	634	

Note: DE mode only

6.4.2 Timing diagram

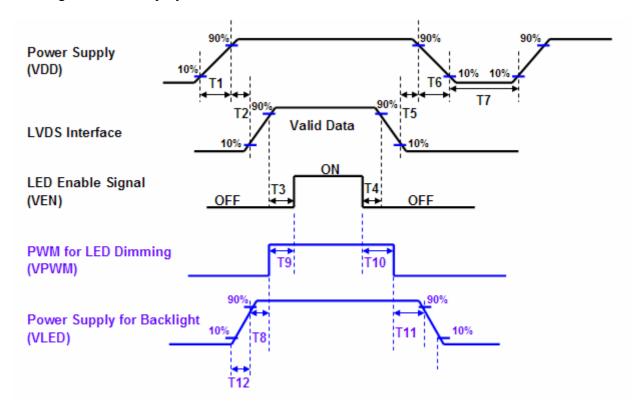




AU OPTRONICS CORPORATION

6.5 Power ON/OFF Sequence

Power on/off sequence is as follows. Interface signals and LED on/off sequence are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off



Power Sequence Timing						
	Val	ue				
Parameter	Min.	Max.	Units			
T1	0.5	10				
T2	0	50				
Т3	200	-				
T4	200	-				
Т5	0	50				
T6	0	10	ms			
Т7	500	-	1115			
Т8	10	-				
Т9	0	180				
T10	0	180				
T11	10	-				
T12	0.5	10				



7. Panel Reliability Test

7.1 Vibration Test

Test Spec:

Test method: Non-Operation

Acceleration: 1.5 G

Frequency: 10 - 500Hz Random

Sweep: 30 Minutes each Axis (X, Y, Z)

7.2 Shock Test

Test Spec:

Test method: Non-Operation

Acceleration: 220 G, Half sine wave

Active time: 2 ms

Pulse: X,Y,Z .one time for each side

7.3 Reliability Test

Items	Required Condition	Note
Temperature Humidity Bias	Ta= 40℃, 90%RH, 300h	
High Temperature Operation	Ta= 50℃, Dry, 300h	
Low Temperature Operation	Ta= 0℃, 300h	
High Temperature Storage	Ta= 60℃, 35%RH, 300h	
Low Temperature Storage	Ta= -20℃, 50%RH, 250h	
Thermal Shock Test	Ta=-20℃to 60℃, Duration at 30 min, 100 cycles	
ESD	Contact : ±8 KV Air : ±15 KV	Note 1

Note1: According to EN 61000-4-2, ESD class B: Some performance degradation allowed. Self-recoverable.

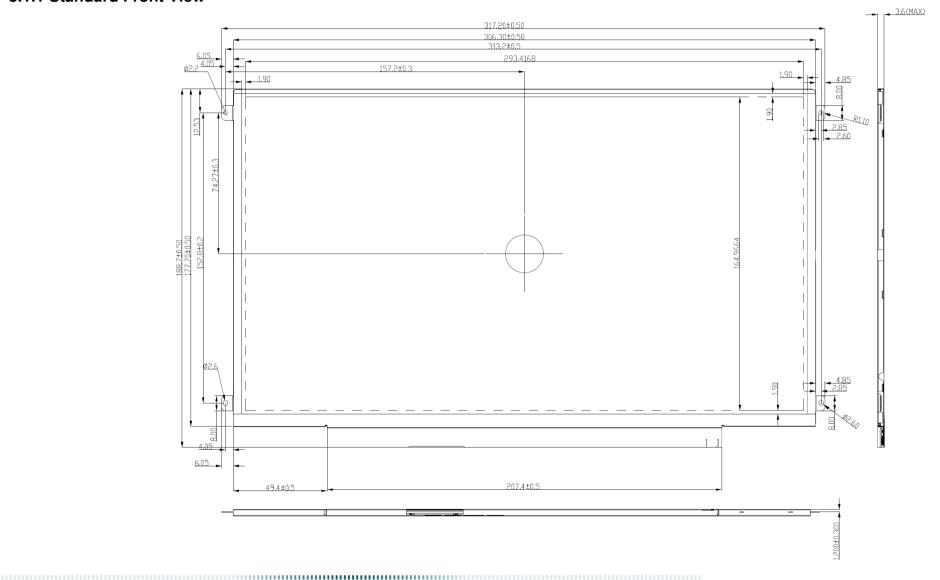
No data lost, No hardware failures.

Remark: MTBF (Excluding the LED): 30,000 hours with a confidence level 90%



AU OPTRONICS CORPORATION

- 8. Mechanical Characteristics
- **8.1 LCM Outline Dimension**
- 8.1.1 Standard Front View

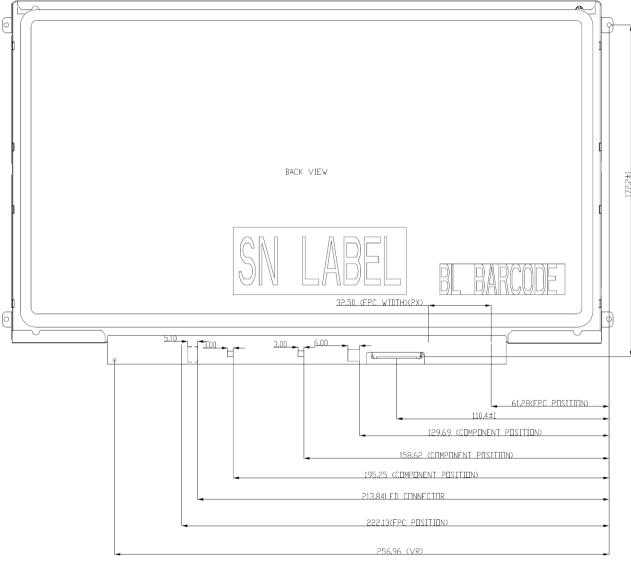




AU OPTRONICS CORPORATION

8.1.2 Standard Rear View & Key components remark and remind

Prevention damage the IC, connector, Capacitor...., we recommend your design (Ex: cable, rib, hardness parts) far away those section those have remarked at this drawing.



Note: Prevention IC damage, IC positions not allowed any overlap over these areas.

B133XW04 V0 <u>Document Version : 0.1</u> 25 of 32



9. Shipping and Package

9.1 Shipping Label Format



Manufactured MM/V/V/ Model No: B133XW03 V3 AU Optronics MADE IN CHINA (S1)

HW: 0A FW:1



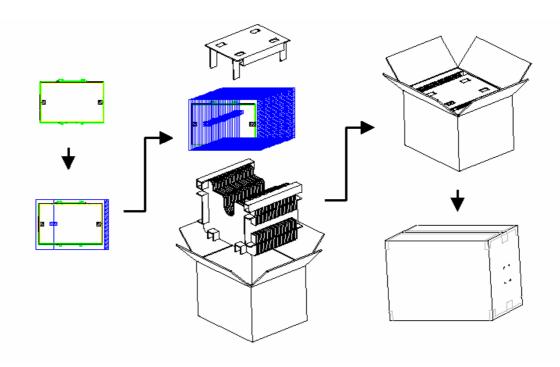




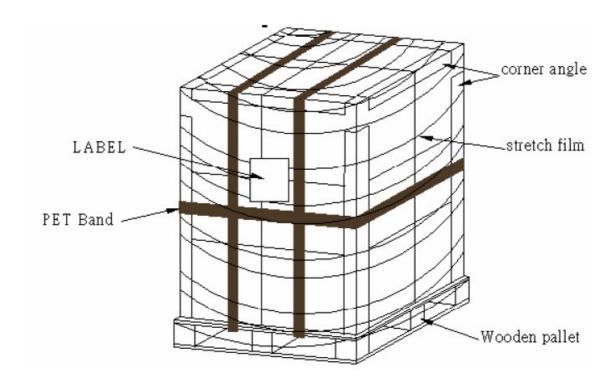


9.2 Carton Package

The outside dimension of carton is 455 (L)mm x 380 (W)mm x 355 (H)mm



9.3 Shipping Package of Palletizing Sequence





10.1 EDID Description

Address	FUNCTION	Value	Value	Value	Note
HEX		HEX	BIN	DEC	
00	Header	00	00000000	0	
01		FF	11111111	255	
02		FF	11111111	255	
03		FF	11111111	255	
04		FF	11111111	255	
05		FF	11111111	255	
06		FF	11111111	255	
07		00	00000000	0	
08	EISA Manuf. Code LSB	06	00000110	6	
09	Compressed ASCII	AF	10101111	175	
0A	Product Code	2C	00101100	44	
0B	hex, LSB first	33	00110011	51	
0C	32-bit ser #	00	00000000	0	
0D		00	00000000	0	
0E		00	00000000	0	
0F		00	00000000	0	
10	Week of manufacture	00	00000000	0	
11	Year of manufacture	13	00010011	19	
12	EDID Structure Ver.	01	0000001	1	
13	EDID revision #	03	00000011	3	
14	Video input def. (digital I/P, non-TMDS, CRGB)	80	10000000	128	
15	Max H image size (rounded to cm)	1D	00011101	29	
16	Max V image size (rounded to cm)	10	00010000	16	
17	Display Gamma (=(gamma*100)-100)	78	01111000	120	
	Feature support (no DPMS, Active OFF, RGB,				
18	tmg Blk#1)	0A	00001010	10	
19	Red/green low bits (Lower 2:2:2:2 bits)	15	00010101	21	
1A	Blue/white low bits (Lower 2:2:2:2 bits)	85	10000101	133	
1B	Red x (Upper 8 bits)	97	10010111	151	
1C	Red y/ highER 8 bits	58	01011000	88	
1D	Green x	53	01010011	83	
1E	Green y	8A	10001010	138	
1F	Blue x	26	00100110	38	
20	Blue y	25	00100101	37	



21	White x	50	01010000	80	
22	White y	54	01010100	84	
23	Established timing 1	00	00000000	0	
24	Established timing 2	00	00000000	0	
25	Established timing 3	00	00000000	0	
26	Standard timing #1	01	00000001	1	
27		01	00000001	1	
28	Standard timing #2	01	00000001	1	
29		01	0000001	1	
2A	Standard timing #3	01	00000001	1	
2B		01	0000001	1	
2C	Standard timing #4	01	0000001	1	
2D		01	0000001	1	
2E	Standard timing #5	01	0000001	1	
2F		01	0000001	1	
30	Standard timing #6	01	0000001	1	
31		01	0000001	1	
32	Standard timing #7	01	0000001	1	
33		01	0000001	1	
34	Standard timing #8	01	00000001	1	
35		01	0000001	1	
36	Pixel Clock/10000 LSB	26	00100110	38	
37	Pixel Clock/10000 USB	1B	00011011	27	
38	Horz active Lower 8bits	56	01010110	86	
39	Horz blanking Lower 8bits	64	01100100	100	
3A	HorzAct:HorzBlnk Upper 4:4 bits	50	01010000	80	
3B	Vertical Active Lower 8bits	00	00000000	0	
3C	Vertical Blanking Lower 8bits	16	00010110	22	
3D	Vert Act: Vertical Blanking (upper 4:4 bit)	30	00110000	48	
3E	HorzSync. Offset	30	00110000	48	
3F	HorzSync.Width	20	00100000	32	
40	VertSync.Offset : VertSync.Width	36	00110110	54	
41	Horz‖ Sync Offset/Width Upper 2bits	00	00000000	0	
42	Horizontal Image Size Lower 8bits	25	00100101	37	
43	Vertical Image Size Lower 8bits	A4	10100100	164	
44	Horizontal & Vertical Image Size (upper 4:4 bits)	10	00010000	16	
45	Horizontal Border (zero for internal LCD)	00	00000000	0	
46	Vertical Border (zero for internal LCD)	00	00000000	0	
47	Signal (non-intr, norm, no stero, sep sync, neg	18	00011000	24	



	pol)				
48	Detailed timing/monitor	00	00000000	0	
49	descriptor #2	00	00000000	0	
4A		00	00000000	0	
4B		0F	00001111	15	
4C		00	00000000	0	
4D		00	00000000	0	
4E		00	00000000	0	
4F		00	00000000	0	
50		00	00000000	0	
51		00	00000000	0	
52		00	00000000	0	
53		00	00000000	0	
54		00	00000000	0	
55		00	00000000	0	
56		00	00000000	0	
57		00	00000000	0	
58		00	00000000	0	
59		20	00100000	32	
5A	Detailed timing/monitor	00	00000000	0	
5B	descriptor #3	00	00000000	0	
5C		00	00000000	0	
5D		FE	11111110	254	
5E		00	00000000	0	
5F	Manufacture	41	01000001	65	Α
60	Manufacture	55	01010101	85	U
61	Manufacture	4F	01001111	79	0
62		0A	00001010	10	
63		20	00100000	32	
64		20	00100000	32	
65		20	00100000	32	
66		20	00100000	32	
67		20	00100000	32	
68		20	00100000	32	
69		20	00100000	32	
6A		20	00100000	32	
6B		20	00100000	32	
6C	Detailed timing/monitor	00	00000000	0	
6D	descriptor #4	00	00000000	0	



6E		00	00000000	0	
6F		FE	11111110	254	
70		00	00000000	0	
71	Manufacture P/N	42	01000010	66	В
72	Manufacture P/N	31	00110001	49	1
73	Manufacture P/N	33	00110011	51	3
74	Manufacture P/N	33	00110011	51	3
75	Manufacture P/N	58	01011000	88	Х
76	Manufacture P/N	57	01010111	87	W
77	Manufacture P/N	30	00110000	48	0
78	Manufacture P/N	33	00110011	51	3
79	Manufacture P/N	20	00100000	32	
7 A	Manufacture P/N	56	01010110	86	V
7B	Manufacture P/N	33	00110011	51	3
7C		20	00100000	32	
7D		0A	00001010	10	
7E	Extension Flag	00	00000000	0	
7F	Checksum	47	01000111	71	



10.2 Color Standardization Photographs

Standardization photographs have declared by AUO

TFT panel character has corresponding with photographs optimum setting

